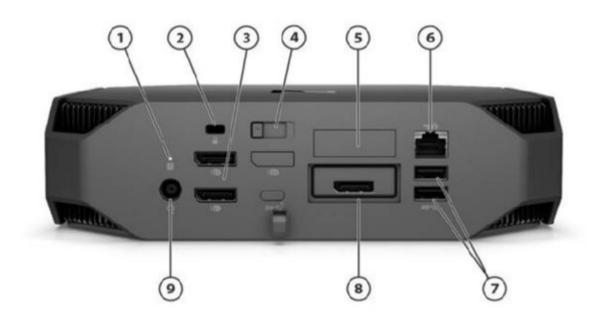
## **HP Z2 Mini G4 Workstation**



### **Front View**

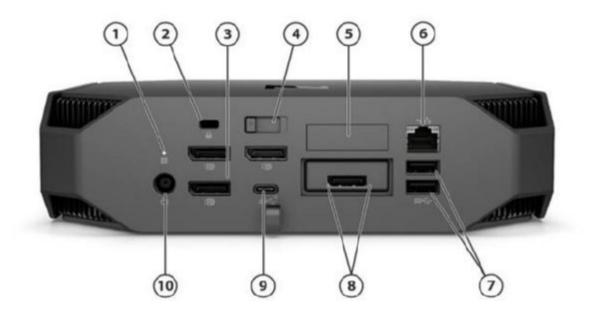
- 1. Power Button
- 2. Headphones/Microphone combo port
- 3. USB 3.0 charging data port
- 4. USB 3.0 data port
- 5. (1) USB Type C<sup>TM</sup>



### HP Z2 Mini G4 Entry, back view

- 1. HDD LED
- 2. Security slot
- 3. (2) DisplayPort<sup>TM</sup>
- 4. Cover latch
- 5. Serial port (optional)

- 6. RJ-45 (Ethernet)
- 7. (2) USB 3.0 ports
- 8. Flexible IO module (supports VGA/HDMI/DisplayPort<sup>TM</sup>/2<sup>nd</sup> RJ-45/USB-C 3.1 Gen2 Charging Data Port/Thunderbolt<sup>TM</sup> 3.0)
- 9. DC In



### HP Z2 Mini G4 Performance, back view

- 1. HDD LED
- 2. Security slot
- 3. (3) DisplayPort™
- 4. Cover latch
- 5. Serial port (optional)
- 6. RJ-45 (Ethernet)

- 7. (2) USB 3.0 ports
- 8. Flexible IO module (supports VGA/HDMI/DisplayPort<sup>TM</sup>/2<sup>nd</sup> RJ-45/USB-C 3.1 Gen2 Charging Data Port/Thunderbolt<sup>TM</sup> 3.0)
- 9. (1) USB Type C<sup>TM</sup>
- 10. DC In





### HP Z2 Mini G4 Entry, Internal View

- 1. SATA HDD/SSD (9.5mm 2.5"?)
- 2. CPU heatsink
- 3. CPU blower
- 4. M.2 80mm (PCIe SSD)

- 1. M.2 30mm WLAN/BT (location change, TBD)
- 2. (2) SODIMM memory slots





### HP Z2Mini G4 Performance, Internal View

- 1. SATA HDD/SSD (9.5mm 2.5"?)
- 2. CPU heatsink
- 3. CPU blower
- 4. M.2 80mm (PCIe SSD)

- 1. GPU heatsink (underneath HDD/SSD cage)
- 2. M.2 30mm WLAN/BT (location change, TBD)
- 3. (2) SODIMM memory slots
- 4. GPU blower



HP Z2 G4 Mini, bottom view

Removable bottom feet for access to integrated VESA mounting holes

# Form Factor Operating Systems

#### Mini Form Factor

#### Preinstalled:

- Windows 10<sup>1</sup>
- Windows 10 Pro 64<sup>1</sup>
- Windows 10 Pro (National Academic License)1
- Windows 10 Pro for Workstations HP recommends Windows 10 Pro <sup>1</sup>
- HP Linux® -readv

#### Supported:

- Red Hat® Enterprise Linux Workstation (1 year paper license available; Preinstall not available)
   Notes: For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux\_hardware\_matrix
- Not all features are available in all editions or versions of Windows. Systems
  may require upgraded and/or separately purchased hardware, drivers, software
  or BIOS update to take full advantage of Windows functionality. Windows 10 is
  automatically updated, which is always enabled. ISP fees may apply and
  additional requirements may apply over time for updates. See
  <a href="http://www.windows.com">http://www.windows.com</a>

### Overview

#### Processors\*

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology³	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro <sup>TM</sup> Technology <sup>4</sup>	16GB Intel® Optane <sup>TM</sup> memory <sup>2,*</sup>	TDP (W)
			Z2	Mini G4	Performa	nce base un	it			
Intel® Xeon®										
processor	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics P630	Y	N	80W
E-2176G <sup>1</sup>			<u> </u>							
Intel® Xeon®							Intel® UHD			
processor	4	3.8	4.7	8	2666	Y	Graphics P630	Υ	N	71W
E-2174G <sup>1</sup>										<u> </u>
Intel® Xeon®										
processor	4	3.6	4.5	8	2666	Y	Intel® UHD	Υ	N	71W
E-2144G <sup>1</sup>							Graphics P630			
Intel® Xeon®	ī									i
processor	6	3.3	4.5	12	2666	Υ	N/A	Υ	N	80W
F 24261		د.د	4.5	12	2000	ı ı	IN/A	ĭ	IN	OUW
E-2136 <sup>1</sup>										
Intel® Xeon® processor							Intel® UHD			
processor	6	3.3	4.5	12	2666	N	Graphics P630	Υ	N	80W
E-2126G <sup>1</sup>										<u> </u>
Intel® Xeon®										
processor	4	3.4	4.3	8	2666	N	Intel® UHD	γ	N	71W
E-2124G <sup>1</sup>							Graphics P630			
Intel® Xeon®										
processor	4	2.2	N/A		2000	N	Intel® UHD		M	65W
·	4	3.2	N/A	8	2666	l N	Graphics P630	Y	N	65W
E-2104G <sup>1</sup>				<u> </u>		<u> </u>				
Intel® Core <sup>TM</sup> i7-8700 processor <sup>1</sup>	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Υ	N	65W
			J <u> </u>				arapines 050			
Intel® Core <sup>TM</sup> i7+8700										
processor (Core i7 and 16GB Intel® Optane <sup>TM</sup>	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Υ	Υ	65W
memory) <sup>1,2,*</sup>							Grapines 030			
Intel® Core <sup>TM</sup> i5-8600			<u> </u>				Intel® UHD			
processor <sup>1</sup>	6	3.1	4.2	9	2666	N	Graphics 630	Υ	N	65W
Intel® Core <sup>TM</sup> i5+8600										
processor (Core i5 and				_			Intel® UHD	<u> </u>		
16GB Intel® Optane <sup>TM</sup>	6	3.1	4.2	9	2666	N	Graphics 630	Υ	Υ	65W
memory) <sup>1,2,*</sup>										
Intel® Core <sup>TM</sup> i5-8500					3		Intel® UHD	,,		
processor <sup>1</sup>	6	3.0	4.0	9	2666	N	Graphics 630	Y	N	65W
Intel® Core <sup>TM</sup> i5+8500										
processor (Core i5 and	6	2.0	4.0		3666	, and	Intel® UHD	Υ	Υ	ELM.
16GB Intel® Optane <sup>TM</sup>	0	3.0	4.0	9	2666	N	Graphics 630	Y	Y	65W
memory) <sup>1,2,*</sup>										

#### Overview

Intel® Core <sup>TM</sup> i3-8100 processor <sup>1</sup>	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	N	65W
Intel® Pentium <sup>TM</sup> G5400 processor <sup>1</sup>	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics 610	N	N	54W
				Z2 Mini	i G4 Entry	base unit				
Intel® Xeon® processor E-2104G <sup>1</sup>	4	3.2	N/A	8	2666	N	Intel® UHD Graphics P630	Y	N	65W
Intel® Core <sup>TM</sup> i7-8700 processor <sup>1</sup>	6	3.2	4.6	12	2666	Υ	Intel® UHD Graphics 630	Υ	N	65W
Intel® Core <sup>TM</sup> i7+8700 processor (Core i7 and 16GB Intel® Optane <sup>TM</sup> memory) <sup>1,2,*</sup>	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core <sup>TM</sup> i5-8600 processor <sup>1</sup>	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Υ	Y	65W
Intel® Core <sup>TM</sup> i5+8600 processor (Core i5 and 16GB Intel® Optane <sup>TM</sup> memory) <sup>1,2,*</sup>	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core <sup>TM</sup> i5-8500 processor <sup>1</sup>	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Υ	Y	65W
Intel® Core <sup>TM</sup> i5+8500 processor (Core i5 and 16GB Intel® Optane <sup>TM</sup> memory) <sup>1,2,*</sup>	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core <sup>TM</sup> i3-8100 processor <sup>1</sup>	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	Y	65W
Intel® Pentium <sup>TM</sup> G5400 processor <sup>1</sup>	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics 610	N	N	54W

<sup>1</sup>Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessal benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardward and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>2</sup>Intel® Optane<sup>TM</sup> memory system acceleration does not replace or increase the DRAM in your system.

\*16GB Intel® Optane<sup>TM</sup> memory Available Fall 2018

<sup>3</sup>The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <a href="http://www.intel.com/technology/turboboost">http://www.intel.com/technology/turboboost</a> for more information.

<sup>4</sup>vPro. Some functionality of this technology, such as Intel® Active management technology and Intel® Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances"? applications for Intel vPro technolog dependent on third-party software providers. Compatibility of this generation of Intel vPro technology-based hardware with future "virtual appliances"? is yet to be determined.

#### Overview

#### **NOTES:**

Integrated Intel® UHD graphics P630 is supported on select Intel® Xeon® E processors.

Intel® Xeon® E, Intel® Core<sup>TM</sup> i3 and Pentium can support either ECC or non-ECC memory; Intel® Core<sup>TM</sup> i5/i7 processors only support non-ECC memory.

**NOTE:** In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on produc configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <a href="http://www.support.hp.com">http://www.support.hp.com</a>.

**Color** Space grey with black chrome accents

**Convertibility** The Z2Mini G4 can either be placed flat on the desktop or mounted behind a display\* or under a desk.

\* Mounting hardware sold separately.

**Expansion Slots** 1 MXM slot (PCIe Gen3 x16) \*

(see system board section 1 80mm M.2 Storage slot (PCIe Gen3 x4) for more details) 1 30mm M.2 WLAN slot (PCIe Gen3 x1) \*\*

\* Performance only

\*\* For WLAN/BT M.2 module only

**Expansion Bays** (see 1 internal 2.5" bay (for SATA HDDs & SSDs only)

system board section for

more details)

Front I/O Power button

Slide I/O 1 USB-A 3.0 Charging Data Port, 1 USB 3.0 data port, combo headset/microphone port

and 1 USB-C 3.1 Gen2 Charging Data Port.

Rear I/O Z2 Mini G4 Entry: 2 DisplayPort<sup>TM</sup> (DP 1.2) outputs from Intel® UHD graphics, 2 USB 3.0 ports, 1 serial port

(optional), RJ-45 (LoM)

1 Flexible module port output (Optional Flexible module required)

**Z2 Mini G4 Performance<sup>1</sup>:** 3 DisplayPort<sup>TM</sup> (DP 1.2) outputs from discrete graphic module, 2 USB-A 3.0

ports, 1 USB 3.1 G2 Type-C<sup>TM</sup> ports, 1 serial port (optional), RJ-45 (LOM) 1 Flexible module port output (Optional Flexible module required)

**NOTE 1:** Performance system is capable of supporting 6 displays. 6 display solution is achieved using a combination of Intel® UHD graphics and discrete graphics and is ONLY supported on Windows 10.

**Chassis Dimensions** 

(H x W x D)

Standard desktop orientation: 58 x 216 x216 mm (2.28 x 8.5 x 8.5 in)

Weight Exact weights depend upon configuration;

Minimum Weight: 1.93 kg (4.25 lb) Typical Weight\*: 2.18 kg (4.80 lb) Maximum Weight: 2.23 kg (4.91 lb)

Max Supported Weight (desktop orientation): 35 kg (77 lb)

\* Configured with 1 2.5" hard drive, 1 PCIe SSD, WLAN module, 2 DIMMs and 1 NVIDIA® Quadro® graphics

card

**Power Supply** Z2 Mini G4 Entry:

135W 88% Efficiency at 115Vac

Z2 Mini G4 Performance: 200W 89% Efficiency at 230Vac

230W 89% Efficiency

NOTES: Customers placing their system in an enclosure should design their solution to accommodate the

size of the external power supply for the Z2 Mini G4

**Chipset** Intel® C246 chipset

Memory 2 SODIMM slots, supporting up to 32GB ECC/non-ECC, DDR4 2666 MT/s

#### Overview

The CPUs determine the speed at which the memory is clocked. If a 2666 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2666 MT/s regardless of the specified speed of the memory.

Note: Transfer rates up to 2666MT/s

**Workstation ISV** See the latest list of certifications at

**Certifications** http://www.hp.com/united-states/campaigns/workstations/partnerships.html



### **Supported Components**

Processors		Factory Configured	Option Kit
	Intel® Xeon® processor E-2100 family <sup>2</sup>		
	Intel® Xeon® processor E-2176G <sup>1</sup>	Υ	N
	Intel® Xeon® processor E-2174G <sup>1</sup>	Υ	N
	Intel® Xeon® processor E-2144G <sup>1</sup>	Υ	N
	Intel® Xeon® processor E-2136 <sup>1</sup>	Υ	N
	Intel® Xeon® processor E-2124G <sup>1</sup>	Υ	N
	Intel® Xeon® processor E-2104G	Υ	N
	8th generation Intel® Core <sup>TM</sup> processor family <sup>3</sup>		
	Intel® Core <sup>TM</sup> i7-8700 3.2 26666 6C CPU	Υ	N
	Intel® Core <sup>TM</sup> i7+8700 (Core i7 and 16GB Intel® Optane <sup>TM</sup> memory*) 3.2 26666 6C CPU	Υ	N
	Intel® Core <sup>TM</sup> i5-8600 3.1 2666 6C CPU	Υ	N
	Intel® Core <sup>TM</sup> i5+8600 (Core i5 and 16GB Intel® Optane <sup>TM</sup> memory*) 3.1 2666 6C CPU	Υ	N
	Intel® Core <sup>TM</sup> i5-8500 3.0 2666 6C CPU	Υ	N
	Intel® Core <sup>TM</sup> i5+8500 (Core i5 and 16GB Intel® Optane <sup>TM</sup> memory*) 3.0 2666 6C CPU	Υ	N
	8th generation Intel® Core <sup>TM</sup> i3/Pentium processor family <sup>2</sup>		
	Intel® Core <sup>TM</sup> i3-8100 3.6 2400 4C CPU	Υ	N
	Intel® Pentium® G5400 3.7 2400 2C CPU	Υ	N

NOTE 1: Only supported on Z2 Mini G4 Performance Base Unit

NOTE 2: These processor support either ECC or non-ECC memory

**NOTE 3:** These processors support only non-ECC memory

NOTE 4: Intel® Integrated Graphics P630 for Xeon® processors supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to International **UHD** Graphics 630.

NOTE 5: Intel® Optane<sup>TM</sup> memory system acceleration does not replace or increase the DRAM in your syst

<sup>\*16</sup>GB Intel® Optane<sup>TM</sup> memory Available Fall 2018

Monitors / Displays		Factory Configured	Option Kit	Option Kit Part Number
	HP Z Display Z27n G2 27-inch IPS LED Backlit Monitor		Υ	1JS10AA
	HP Z Display Z24n G2 24-inch IPS LED Backlit Monitor		Υ	1JS09AA
	HP Z Display Z24nf G2 23.8-inch IPS Backlit Monitor		Υ	1JS07AA
	HP Z Display Z23n G2 23-inch IPS LED Backlit Monitor		Υ	1JS06AA
	HP Z Display Z22n G2 21.5-inch IPS LED Backlit Monitor		Υ	1JS05AA
Notes	Supported by all Operating Systems available from HP Screen Size Diagonally Measured			

### **Supported Components**

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s SFF HDD	Υ	Υ	T0K73AA
	1TB SATA 7200 rpm 6Gb/s SFF HDD	Υ	Υ	TOK74AA
SATA Solid State Drives	HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA
	16GB Intel® Optane <sup>TM</sup> memory*,**	Υ	Υ	TDB

<sup>\*</sup>Intel® Optane<sup>TM</sup> memory (cache) is sold separately. Intel® Optane<sup>TM</sup> memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core<sup>TM</sup> processor or Intel® Xeon® processor E-2100 product family or higher, BIOS version with Intel® Optane<sup>TM</sup> supported, Windows 10 version 1703 or higher, M.2 type 2280-S1--M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with M keys that meet NVMe<sup>TM</sup> Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

PCIe SSDs	PCIe SSDs for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number
	HP Z Turbo Drive G2 256GB TLC (Z2 Mini G4)	Υ	Υ	Y7B60AA
	HP Z Turbo Drive G2 512GB TLC (Z2 Mini G4)	Υ	Υ	
	HP Z Turbo Drive G2 1TB TLC (Z2 Mini G4)	Υ	Υ	
	** Installed in native M.2 storage slot on Z2 Mini G4			

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Integrated Graphics	Integrated Intel® UHD Graphics (Z2G4)				
	Intel® UHD Graphics P630	Υ	N		1
	Intel® UHD Graphics 630	Υ	N		1
	Intel® UHD Graphics 610	Y	N		1
Discrete Graphics	NVIDIA® Quadro® P600 4GB Graphics <sup>1</sup>	Υ	Υ	3TQ28AA	1
	NVIDIA® Quadro® P1000 4GB Graphics <sup>1</sup>	Υ	Υ	3TQ29AA	1
	AMD Radeon <sup>TM</sup> Pro WX 4150 4GB Graphics <sup>1,2</sup>	Υ	Υ	3TQ30AA	1
Graphics DisplayPort <sup>TM</sup>	HP DisplayPort <sup>TM</sup> To DVI-D Adapter	Υ	Υ	FH973AA	
Cable Adapters	HP DisplayPort™ To VGA Adapter	N	Υ	AS615AA	
	HP DisplayPort™ to Dual Link DVI Adapter	N	Υ	NR078AA	
	HP DisplayPort™ to HDMI Adapter	N	Υ		
	HP USB-C to VGA Adapter	N	Υ		
	HP USB-C to HDMI Adapter	N	Υ		
	HP USB-C to DP Adapter	N	Υ		

<sup>\*\*16</sup>GB Intel® Optane<sup>TM</sup> memory Available Fall 2018



#### Notes

NOTE 1: Only offered on Z2 Mini G4 Performance base unit

NOTE 2: AMD Radeon<sup>TM</sup> Pro WX 4150 Graphics Available Fall 2018

**NOTE:** Intermixing integrated Intel® UHD graphics and discrete graphics cards to drive more than three displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discipraphics when four or fewer displays are required to be supported. 6 display solution is achieved using a combination of Intel® UHD graphics and discrete graphics and is ONLY supported on Windows 10.

#### Memory

#### DDR4-2666 ECC Unbuffered SODIMMs - CTO

HP 8GB (1x8GB) DDR4-2666 ECC SODIMM HP 16GB (2x8GB) DDR4-2666 ECC SODIMM HP 32GB (2x16GB) DDR4-2666 ECC SODIMM

#### DDR4-2666 non-ECC Unbuffered SODIMMs - CTO

HP 4GB (1x4GB) DDR4-2666 nECC SODIMM HP 8GB (2x4GB) DDR4-2666 nECC SODIMM HP 8GB (1x8GB) DDR4-2666 nECC SODIMM HP 16GB (2x8GB) DDR4-2666 nECC SODIMM HP 32GB (2x16GB) DDR4-2666 nECC SODIMM

**NOTES:** Intel® Xeon® E, Intel® Core<sup>TM</sup> i3 and Intel® Pentium® processors can support either ECC or non-ECC memory; Intel® Core<sup>TM</sup> i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 2666 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2666 MT/s regardless of the specified speed of the memory.

AMO	Option Kit Part Number
DDR4-2666 ECC Unbuffered SODIMMs - AMO	
HP 8GB (1x8GB) DDR4-2666 ECC RAM	3TQ37AA
HP 16GB (1x16GB) DDR4-2666 ECC SODIMM	3TQ38AA
HP 4GB (1x4GB) DDR4-2666 non-ECC RAM	3TQ34AA
HP 8GB (1x8GB) DDR4-2666 non-ECC RAM	3TQ35AA
HP 16GB (1x16GB) DDR4-2666 non-ECC RAM	3TQ36AA

**NOTE:** Only unbuffered DDR4 SODIMMs are supported.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	
	Integrated Conexant CX20632 5.1 HAD Audio	Υ	N		

### **Supported Components**

Optical and Removable	Factory	Option Kit Part
Storage	Configured Option Kit	Number
HP SlimTray Optical Drives		

... Junitary options 2000

HP External Ultra-Slim DVD-RW Drive N Y Y3T76AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyrig protected materials. Intended for creation and storage of your original material and other lawful uses. Dou Layer discs can store more data than single layer discs. However, double-layer discs burned with this driv may not be compatible with many existing single-layer DVD drives and players.

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro <sup>TM</sup> with Intel® AMT 12.0)	Υ	N	
	Intel® 9560 Wireless LAN (802.11ac) and Bluetooth® 5 Module	Υ	N	

**NOTE 1:** The integrated network connection is required to support Intel® vPro<sup>TM</sup> Technology. **NOTE 2:** If AMT is provisioned, then network teaming with the integrated LAN port is not possible. **NOTE 3:** "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Keyed Cable Lock 10mm	N	Υ	T1A62AA
	Kensington Lock	N	Υ	
	Z2 Mini Sleeve	N	Υ	3RW68AA

Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP USB Optical Mouse	Υ	Υ	QY777AA
	HP USB Hardened Mouse	Υ	Υ	P1N77AA
	HP USB Premium Mouse	Υ	Υ	
	HP Premium Wireless Mouse	Υ	Υ	
	SpaceMouse Pro USB 3D Input Device	N	Y	
	3Dconnexion CADMouse	N	Υ	M5C35AA
	HP USB Business SlimCCID SmartCard Keyboard	Υ	Υ	
	HP USB Business Slim Keyboard	Υ	Υ	
	HP USB Premium Keyboard	Υ	Υ	N3R87AA
	HP Premium Wireless Keyboard	Υ	Υ	
	HP Wireless Business Slim Keyboard & Mouse	Υ	Υ	



Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Serial Port Adapter	Υ	N	PA716A
	HP Z2 Mini G4 VESA Sleeve	N	Υ	Y7B61AA
	Z2 Mini G4 Z Display VESA Mount Solution - Current Displays	i N	Υ	N6N00AA*
	Z2 Mini G4 Z Display VESA Mount Solution - Legacy Displays	N	Υ	E5J35AA**
	HP Elite USB-C Docking Station (TBD)	N	Υ	

 $<sup>^{\</sup>star}$  Current: "n" displays. This mounting kit supports the following displays: Z2G42n/Z2G43n/Z2G44n/Z2G45n/Z2G47n,

<sup>\*\*</sup> Legacy: "I" displays. This mounting kit supports the following displays: Z2G44i/Z2G47i/Z30i, /Z30i/Z2G44x/Z2G47x.

Rear Module Options	Factory Configured	Option Kit	
HP Flex IO module (VGA)	Υ	Υ	3TK80AA
HP Flex IO module (HDMI-iGfx)	Υ	Υ	3TK74AA
HP Flex IO module (DP)	Υ	Υ	3TK72AA
HP Flex IO module (USB-C)	Υ	Υ	4KY84AA
HP Flex IO module (Thunderbolt <sup>™</sup> 3.0)	Υ	Υ	3TQ25AA
HP Flex IO module (1 GbE LAN)	Υ	Υ	3TQ26AA
HP Serial Port Mini module	Υ	Υ	3TQ27AA

Software	Factory	Factory		
	Configured	Option Kit	Notes	
HP Performance Advisor	Υ	N	See Note 1	
HP Remote Graphics Software (RGS) 7.x	Υ	N		
HP PC Hardware Diagnostics UEFI	Υ	N	See Note 2	

**NOTE 1**: Supports, and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor

**NOTE 2:** Windows OS only

<sup>/</sup>Z2G44nf/Z2G44nq/Z2G44s/Z2G47q/Z32s/Z32x/HC240/HC270/E240c/E272.



#### **Operating Systems**

Windows 10 Home 64 Windows 10 Pro 64

Windows 10 Pro (National Academic License)

Windows 10 Pro for Workstations - HP recommends Windows 10 Pro Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)

**NOTE:** For detailed QS/hardware support information for Linux, see:

http://www.hp.com/support/linux\_hardware\_matrix

#### **HP BIOS**

#### Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Z2 G4 Workstation into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 14 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.6
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP
  Business Desktop computers, including BIOS updates from within Windows (HP
  Firmware Update and Recovery), HP Client Manager, and fail-safe recovery. In
  addition, the HP BIOS Configuration Utility enables replication of BIOS settings
  within Windows while the Replicated Setup feature provides the same capability
  within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP
  support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

#### Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS. and changes cannot



be made to BIOS settings using BIOS Setup or under the OS. and changes cannot be made to BIOS settings using BIOS Setup or under the OS.

- S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Maximum Power Savings feature is enabled below features are turned off:
  - -Power to expansion connectors / slots
  - -Wake events other than power buttons (such as wake on LAN)
  - -USB charging ports

#### **HP Sure Start Gen4 Start**

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot. and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot. and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processo



#### **Remote Power On**

#### **Benefits of the Remote Power:**

- Make it easier to power-on HP Z2 Mini G4 Workstation by USB keyboard/mouse in some use scenarios.
- Support wired/wireless, USB low speed/full speed keyboards and mousses.
- Easy setup in BIOS menu.
- Support waking from both S4 (Hibernate) and S5 (Shutdown).

#### **Limitations:**

• Waking from S4/S5 is limited to only via keyboard/mouse device.

#### **Instructions:**

- 1. Connect USB keyboard/mouse to USB port.
- 2. System must recognize USB keyboard/mouse in SO first. (USB full speed keyboard/mouse, such as wireles keyboard/mouse or Smart card keyboard need to connect to system over 60 seconds in SO to be recogniz on charging port.)
- 3. Sleep to S4 or S5.
- 4. Wake system by any key on keyboard or clicking/movement\* on mouse.
  - \* If mouse has the capability to wake system by movement

### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS
HP BIOSphere Gen4<sup>17</sup>
HP DriveLock & Automatic
BIOS Update via Network
Master Boot Record Security
Power On Authentication Authentication
Secure Erase <sup>18</sup>
Absolute Persistence Module<sup>19</sup>
Pre-boot Authentication
HP Wireless Wakeup

#### Software

**HP Hotkey Support - CMIT** 

Manageability Features HP Driver Packs<sup>22</sup> HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

**HP Client Catalog** 

HP Manageability Integration Kit Gen2<sup>23</sup>

**Client Security Software** 

HP Client Security Suite Gen4<sup>25</sup> including:

HP Security Manager<sup>26</sup> (including Credential Manager, HP Password Manager, HP Spare Key)

**HP Device Access Manager** 

**HP Power On Authentication Authentication** 

Microsoft Defender<sup>27</sup>

### **Supported Components**

**Security Management** 

Secure Erase<sup>18</sup>

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)<sup>32</sup>

SATA port disablement (viaBIOS))

RAID configurations<sup>33</sup>

Serial, USB enable/disable (viaBIOS))

Power-on password (viaBIOS))

Setup password (viaBIOS))

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click<sup>37</sup>

HP Sure Start Gen430

HP Sure Run<sup>35</sup>

HP Sure Recover<sup>36</sup>

17. HP BIOSphere Gen4 features may vary depending on the Workstation platform and configurations requires 8th Gen Intel® processors. Gen4 features may vary depending on the Workstation platform and configurations requires 8th Gen Intel® processor 18. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Workstation platforms with BIOS version F.03 or higher.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolu Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must fir sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchas one or more RSA SecurID tokens from Absolute Software.

- 22. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 23. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supporte User may need to enable or allow the add-on / extension in the internet browser. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- 27. Microsoft Defender Opt in and internet connection required for updates. in and internet connection required for updates.
- 30. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors
- 32. Firmware TPM is version 7.63. Hardware TPM is v2.0. .
- 33. RAID configuration is optional and does require a second hard drive.
- 35. HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.
- 36. HP Sure Recover is available on HP Workstations with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of da 38. HP Sure Click is available on select HP platforms and supports Microsoft® Internet Explorer and Chromium<sup>TM</sup>. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available

### **System Technical Specifications**

**System Board** 

System Board Form Factor Entry: 200mm x 200mm (7.9 x 7.9 inches)

Performance: 200mm x 200mm (7.9 x 7.9 inches)

**Processor Socket** Single LGA 1151

CPU Bus Speed DMI link between CPU & PCH: Performance comparable to PCIe Gen3 x4

**Chipset** Intel® PCH C246

Memory Expansion Slots 2 SODIMM DDR4 memory slots

Memory Type Supported DDR4, UDIMM (Unbuffered), ECC & non-ECC

Memory Modes Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 2666MHz DDR4 for Coffeelake processors;

Memory Protection ECC available on data

\*Requires ECC DIMMs to be installed, as well as a CPU that supports ECC

Maximum Memory 32GB

**Memory Configuration** 

(Supported)

4GB, 8GB and 16GB non-ECC/ 8GB and 16GB ECC unbuffered DIMMs are supported.

ECC and non-ECC memory DIMMs cannot be mixed on the same system.

Notes Maximum memory capacities assume 64-bit operating systems, such as Windows® 10 Professional 64-Bit

or Red Hat Linux 64-bit.

Supported Drive Interfaces

SATA Integrated (1) Serial ATA interfaces (6Gb/s SATA).

**Integrated Graphics** Intel® UHD Graphics 610 (on Pentium<sup>TM</sup> Gold-5xxx processors);

Intel® UHD Graphics 630 (on Core<sup>TM</sup> i3/i5/i7-8xxx processors);

Intel® UHD Graphics P630 for Xeon® E processors based on Unified Memory

Architecture (UMA).

A region of system memory is reserved and dedicated to the graphics

display.

Support for Microsoft DirectX 12.1, OpenGL 4.4 and OpenCL 2.0 on Intel®

UHD Graphics P630.

(2) DP 1.2 graphics ports integrated on motherboard; (1) DP 1.2 graphic

capable through use of Flexible DP module. Supports up to three

simultaneous displays across DP outputs. (Entry)
Max. resolution supported: 4096x2160 @60Hz

(1) DP 1.2 graphics ports integrated on motherboard switchable between intel® graphic and discrete graphic; (1) DP 1.2 graphic capable through use of Flexible DP module switchable between intel® graphic and discrete graphic.

**System Technical Specifications** 

Supports up to three simultaneous displays from Intel® graphic across DP outputs. (2) DP 1.2 graphic port dedicated for display from discrete graphics

(Performance)

Max. resolution supported: 4096x2160 @60Hz

Network Controller Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL,

PXE 2.1 and AMT 12.0

Serial 1 rear port (configurable option)

IEEE 1394 Connector(s)

**USB Connector(s)** Front Side I/O:

2 USB 3.0 Type-A 1 USB 3.1 G1 Type-C<sup>TM</sup>

Rear 2 USB 3.0 Type-A

1 USB 3.1 G2 Type-C<sup>TM</sup> (Z2 Mini G4 Performance only)

**HD Integrated Audio** 

Yes; supports CTIA headset

Flash ROM Yes Chassis Fan Header Yes

Additional CPU/GFX Cooler (Z2 Mini G4 Performance only)

Front Control

Side I/O: Yes

Panel/Speaker Header

CMOS Battery Holder -

Yes

Lithium Integrated Trusted

Integrated TPM 2.0

Platform Module
Power Supply Headers

Yes, single DC-in jack for external power supplies

Power Switch, Power LED & Hard Drive LED Header

1. The power and failure LED are combined in the front power switch.

2. The HDD LED & DC-in LED are combined within one port on the Rear I/O. The LED will be lit once the AC power is plugged in. As soon as the system is booted up, the LED will function as a standard HDD activity

LED. Yes

Clear Password Jumper

Keyboard/Mouse USB

**Power Supply** Z2 Mini G4 Entry: 135W, 88% efficiency, wide-ranging, active PFC Power Supply

Z2 Mini G4 Performance: 200W, 89% efficiency, wide-ranging, active PFC Power Supply Z2 Mini G4 Performance: 230W, 89% efficiency, wide-ranging, active PFC Power Supply

The Z2 Mini G4 PSU Efficiency Report can be found at this link: TBD

Operating Voltage Range 115-230 VAC

Rated Voltage Range 100-240 VAC

**Rated Line Frequency** 50-60 Hz

**Operating Line Frequency** 47-63 Hz

Range

**Rated Input Current** 

Z2 Mini G4 Entry: 1.9A @ 90Vac

Z2 Mini G4 Performance: 2.9A @ 90Vac (200W EPS) Z2 Mini G4 Performance: 3.5A @ 90Vac (230W EPS)

### **System Technical Specifications**

**Heat Dissipation** Typical: TBD btu/hr (TBD kcal/hr)

Maximum: TBD btu/hr (TBD kcal/hr)

**ENERGY STAR® certified** 

(Config Dependent)

Yes

Yes

**FEMP Standby Power** 

Compliant

Yes, with Wake-on-LAN disabled: <1W in S5- Power Off

Surge Tolerant Full Ranging Power Supply (withstands power surges

up to 2000V)

System Configurat	ions								
Z2 Mini G4	Processor Info	1x Intel® Core® i3-8100 3.6 6MB 4C							
	Memory Info	8GB (1x8GB) DDR4-2666 ECC SO-DIMM							
	Graphics Info	Intel® UHD Integrated Graphics 630							
CERTIFIED	Disks/Optical/Floppy	1x 1TB 7200 RP	M SATA HDD / 1	x Z Turbo Drive	G2 512GB PCIe 1	st SSD			
	Power Supply	200W EPS							
	Other	Ethernet Capab	le						
		115	VAC	230	VAC	100	VAC		
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
(Watts)	Windows long Idle (S0)	TBD		TE	BD	TE	BD		
	Windows short Idle (S0)	TBD		TBD		TBD			
	Windows Busy Typ(S0)	TBD		TBD		TBD			
	Windows Busy Max (S0)	TBD		TBD		TBD			
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE	TBD TBD		TBD				
		115	VAC	230 VAC		100 VAC			
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows long Idle (S0)	TE	3D	TBD		TBD			
	Windows short Idle (S0)	TE	3D	TBD		TE	BD		
	Windows Busy Typ(S0)	TE	3D	TBD		TE	BD		
	Windows Busy Max (S0)	TE	3D	TE	3D	TE	BD		
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE	3D	TE	3D	TE	BD		

## **System Technical Specifications**

	Processor Info	1x Intel® Core®	7-8700 3.2 12M	IB 6C					
Z2 Mini G4 Configuration	Z2 Mini G4 Configuratio Memory Info		HP 16GB (2x8GB) DDR4-2666 non-ECC SO-DIMM						
#2 (TBD)	Graphics Info	NVIDIA® Quadro	® P620 GPU						
	Disks/Optical/Floppy	1x 1TB Z Turbo Drive G2 M.2 SSD							
	Power Supply	200W EPS							
	Other	Ethernet Capab	le						
		115	VAC	230	VAC	100	VAC		
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
(Watts)	Windows long Idle (S0)	TE	BD	TE	3D	TE	3D		
	Windows short Idle (S0)	TE	BD	TE	3D	TE	BD .		
	Windows Busy Typ(S0)	TBD		TBD		TBD			
	Windows Busy Max (S0)	TBD		TBD		TBD			
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE	BD	TBD		TBD			
		115	VAC	230	VAC	100	VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows long Idle (S0)	TE	3D	TBD		TBD			
	Windows short Idle (S0)	TE	BD	TBD		TBD			
	Windows Busy Typ(S0)	TBD		TBD		TBD			
	Windows Busy Max (S0)	TE	BD	TBD		TBD			
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE	BD	TE	3D	TE	BD		

	I	T							
Z2 Mini G4	Processor Info		<sup>M</sup> E-2176G 3.7 1						
Configuration #3 (TBD)	Memory Info	32GB (2x16GB)	DDR4-2666 ECC	SO-DIMM					
ENERGY STAR	Graphics Info	AMD® Radeon Pro WX 3150							
CERTIFIED	Disks/Optical/Floppy	1x 500 GB 7200	RPM SATA HDD	1					
	Power Supply	er Supply 230W EPS							
	Other	Ethernet Capab	le						
		115	VAC	230	VAC	100	VAC		
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
(Watts)	Windows long Idle (S0)	TE	3D	TE	3D	TE	3D		
	Windows short Idle (S0)	TE	3D	TE	3D	TBD			
	Windows Busy Typ(S0)	TBD		TBD		TBD			
	Windows Busy Max (S0)	TBD		TBD		TBD			
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE	3D	TBD		TBD			
		115	VAC	230 VAC		100 VAC			
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows long Idle (S0)	TE	3D	TBD		TBD			
	Windows short Idle (S0)	TE	3D	TBD		TBD			
	Windows Busy Typ(S0)	TE	3D	TBD		TE	3D		
	Windows Busy Max (S0)	TE	3D	TE	3D	TE	3D		
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD		
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD		
	Zero Power Mode (ErP)	TE			BD		3D		

**Deskside Sound Pressure** 

(LpAm. decibels)

**Deskside Sound Pressure** 

# QuickSpecs

### **System Technical Specifications**

#### **Declared Noise Emissions Z2 Mini G4 (Entry)**

**Declared Noise Emissions (Entry-level and High-end configurations)** 

System Configuration (Entry level With HDD)

Processor Info Intel® Core<sup>TM</sup> i3-8100 4C

Memory Info 1 - 8GB DDR4-2666 SO-DIMM Memory

**Graphics Info** Intel UHD Graphics

Disks/SSD 1 - Hitachi 500GB SATA 7200RPM HDD

1 - Samsung 256GB PCle M.2 SSD

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296)

Sound Power<br/>(LWAd, bels)Deskside Sound Pressure<br/>(LpAm, decibels)IdleTBDTBDHard drive OperatingTBDTBD

(random reads)

System Configuration (Entry level Only SSD)

**Processor Info** Intel® Core<sup>TM</sup> i3-8100 4C

Memory Info 1 - 8GB DDR4-2666 SO-DIMM Memory

**Graphics Info** Intel UHD Graphics

Disks/SSD N / A

1 - Samsung 256GB PCle M.2 SSD

**Sound Power** 

(LWAd. bels)

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296)

Idle Hard drive Operating

(random reads)

TBD TBD TBD

System Configuration (High-end)

**Processor Info** Intel® Core<sup>TM</sup> i7-8700 6C

Memory Info 2 - 8GB DDR4-2666 SO-DIMM Memory

**Graphics Info** Intel UHD Graphics

Disks/SSD 1 - Hitachi 1TB SATA 7200RPM HDD

1 - Samsung 512GB PCle M.2 SSD

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296)

(LWAd, bels) (LpAm, decibels)

Idle 3.14 19.2

Hard drive Operating 3.18 19.4

(random reads)

**Sound Power** 

**Deskside Sound Pressure** 

# QuickSpecs

**System Technical Specifications** 

#### **Declared Noise Emissions Z2 Mini G4 Performance**

**Declared Noise Emissions (Entry-level and High-end configurations)** 

System Configuration (Entry level With HDD)

Processor Info Intel® Core<sup>TM</sup> i3-8100 SR2HG/3.6G/6M/4c

Memory Info 1 - 4GB DDR4-2666 SO-DIMM Memory

**Graphics Info** NVIDIA® Quadro® P600

Disks/SSD 1 - Hitachi 500GB SATA 7200RPM HDD

1 - Samsung 256GB PCle M.2 SSD

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296)

(LWAd, bels) (LpAm, decibels)

Idle 3.16 20.3

Hard drive Operating 3.17 20.4

(random reads)

**Sound Power** 

System Configuration (Entry level Only SSD)

Processor InfoIntel® CoreTM i3-8100 SR2HG/3.6G/6M/4cMemory Info1 - 4GB DDR4-2666 SO-DIMM Memory

NVIDIA® Quadro® P600

Disks/SSD N / A

**Graphics Info** 

1 - Samsung 256GB PCle M.2 SSD

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296)

Sound Power (LWAd, bels) (LpAm, decibels)

Idle 3.06 19.1

Hard drive Operating / / /

(random reads)

System Configuration (High-end)

Processor Info Intel® Xeon® E-2144 QJ70/3.6G/8M/4c
Memory Info 2 - 8GB DDR4-2666 SO-DIMM Memory
Graphics Info NVIDIA® Quadro® P600

**Disks/SSD** 1 - Hitachi 1TB SATA 7200RPM HDD 1 - Samsung 512GB PCIe M.2 SSD

**Declared Noise Emissions** (in accordance with ISO 7779 and ISO 9296) Sound Power (LWAd, bels) (LpAm, decibels)

Idle 3.21 22.2

Hard drive Operating 3.23 22.7

(random reads)

#### System Technical Specifications

**Environmental** Requirements

**Temperature** Operating: 5° to 35° C (40° to 95° F)

> Above 1524 m (5.000 feet) altitude, the maximum operating temperature is reduced by 1°C (1.8°F) for every 305 m (1,000 feet) increase in elevation

Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

**Maximum Altitude** Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

**Temperature** for details.

Operating  $\frac{1}{2}$ -sine: 40q, 2-3ms (~62 cm/sec) Shock (non-repetitive)

Non-operating ½-sine: 160 cm/s. 2-3 ms (~105 g)

Non-operating square: 422 cm/s, 20 g

Vibration Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g<sup>2</sup>/Hz

Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g<sup>2</sup>/Hz

## **Physical Security and Serviceability**

**Access Panel** 

Tool-less

Includes system board and memory information

**Hard Drives** HDD cage requires the use of a screwdriver to remove the HDD

**Expansion Cards** M.2 module requires a screwdriver to service and replace.

**Processor Socket** Tool-less, except for the processor heatsink.

Color-coordinated Cables Yes

and Connectors

Tool-less Memory

**System Board** Screw-In

**Dual Color Power and HD LED on Front of Computer**  The Power LED is on the front of the system, but the HDD LED is located on the Rear of the system

**Configuration Record SW** Yes

Over-Temp Warning on

Screen

Yes

Restore CD/DVD Set

Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applicatio that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.

#### System Technical Specifications

Switch

**Dual Function Front Power** Yes, causes a fail-safe power off when held for 4 seconds (default) or 15 seconds (can be configured by F10

BIOS setup\Advanced\System Options\Power button override)

Yes, Kensington Cable Lock (optional): Locks top cover from being opened and secures chassis to furniture **Cable Lock Support** 

to prevent theft

3 mm x 7 mm slot at rear of system

Serial, Parallel, USB, Audio. Network. **Enable/Disable Port** 

Yes, enables or disables serial, USB, audio, and network ports (parallel port is not supported on the Z2 Min

G4 G4)

Removable Media **Write/Boot Control** 

**Control** 

Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media

Power-On Password Yes, prevents an unauthorized person from booting up the workstation

**Setup Password** Yes, prevents an unauthorized person from changing the workstation configuration

NIC LEDs (integrated) (Green & Amber)

Yes

**CPUs and Heatsinks** A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be remove

CPU removal is tool-less

**Power Supply Diagnostic** 

**LED** 

Yes; this is located on the Rear of the chassis and combined with the HDD LED.

When the PSU adapter is plugged in, and the unit is powered off, the Power OK LED will glow.

Front Power LED Yes, white (normal), red (fault)

**Internal Speaker** Yes, on the side of the chassis

System/Emergency ROM

Flash Recovery

Recovers corrupted system BIOS.

**Cooling Solution** Air cooled forced convection

**CPU Heatsink Fan** Z2 Mini G4 Entry & Performance CPU blower solution: 11.1 mm x 65mm x 82.1mm

Z2 Mini G4 Performance GPU blower solution: 29mm x 103.6mm x 102.2mm

**Chassis Fan** Z2 Mini G4 Entry: Single system blower

Z2 Mini G4 Performance: Dual system blower

**Memory Heatsink Fan** No

**HP PC Hardware Diagnostics UEFI**  HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from

HP Support.

**Access Panel Key Lock** The Kensington lock slot on the chassis serves this purpose

#### System Technical Specifications

#### **ACPI-Ready Hardware**

Advanced Configuration and Power Management Interface (ACPI).

- Allows the system to wake from a low power mode.
- Controls system power consumption, making it possible to place individual cards and peripherals in a lo power or powered-off state without affecting other elements of the system

### **Trusted Platform Module**

Chip

Yes

M.2 Card Retention

Yes, all M.2 modules are retained by a single screw

Flash ROM

Yes

**Diagnostic Power Switch** 

LED on board

Yes

**Clear Password Jumper** 

Yes

Clear CMOS Jumper

Yes

**CMOS Battery Holder** 

Yes: Z2 Mini G4 Entry

Yes: Z2 Mini G4 Performance

**DIMM Connectors** 

Yes

### Social and Environmental Responsibility

## **Declarations**

Eco-Label Certifications & This product is low halogen except for power cords, cables and peripherals. Service parts obtained after purchase may not be Low Halogen.

- ENERGY STAR® (energy-saving features available on selected configurations -Windows® only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program (CECP)
- IT ECO declaration

#### **Batteries**

The battery in this product complies with EU Directive 2006/66/EC

Battery size: CR2032 (coin cell) Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

#### **Restricted Material Usage**

This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

#### **Low Halogen Statement**

This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card is not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

#### **End-of-Life Management** and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Product: returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

### **System Technical Specifications**

HP Inc. Corporate

For more information about HP's commitment to the environment:

Environmental Information Living Progress Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/alobalcitizenship/environment/productdesign/ecolabels.html

#### ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

#### **Additional Information**

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product is >90% recycle-able when properly disposed of at end of life
- EPEAT® Gold registered in the U.S. EPEAT registration varies by country. See http://www.epeat.ne for registration status by country.

#### **Packaging**

HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen\_specifications.html

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

#### **Packaging Materials**

Internal

Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expandedpolypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).

**External** 

Carton made from corrugated fiberboard with at least 35% recycled content.

### Manageability

## Technology (AMT) v12

Intel® Active Management An advanced set of remote management features and functionality which provides network administrator the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 12 includes the following advanced management functions:

- Support for configuration of Intel AMT 12.0 new capabilities
- No reset after provisioning
- Support changes to BIOS table 130
- Support for Microsoft Windows Server 2012 R2
- Support for New Microsoft SQL Server Versions including Standard and Enterprise editions
- Support for Intel SSD Prop 2500 Series
- Support for Intel Enterprise Digital Fence
- The Platform Discovery Utility can now discover these additional Intel products:
- Intel SSD Pro 2500 Series; Enterprise Digital Fence
- Intel Identity Protection Technology with One Time Password; Public Key Infrastructure; Multi Facto Authentication
- Intel Identity Protection Technology with Intel WiGig
- New Profile Editor and Profile Editor Plugin Interface

### **System Technical Specifications**

• New Required Permissions for Solutions Framework

**HP Image Assistant** 

Visit: http://ftp.hp.com/pub/caps-softpag/cmit/HPIA.html

#### System Software Manager Visit: http://www.hp.com/go/ssm

Service, Support, and Warranty

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisorie by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to cal technical support.

#### Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chose set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	<b>Offering</b> Intel® Xeon E-2124 3.4 8M GT2 4C
		Intel® Xeon E-2144 3.6 8M GT2 4C
Hard Drives	Product #	Offering
		HDD 1TB 7200RPM SATA 2.5 SSD 512GB TLC M.2
Graphics	Product #	Offering NVIDIA® Quadro® P600 4GB Graphics

### **Technical Specifications - Processors**

#### Intel® Xeon® processor E-2100 family

Intel® Xeon® processor E-2176G

Intel® Xeon® processor E-2174G

Intel® Xeon® processor E-2144G

Intel® Xeon® processor E-2136

Intel® Xeon® processor E-2124G

Intel® Xeon® processor E-2104G

#### 8th generation Intel® Core<sup>TM</sup> processor family

Intel® Core<sup>TM</sup> i7-8700 3.2 26666 6C CPU

Intel® Core<sup>TM</sup> i7+8700 (Core i7 and 16GB Intel® Optane<sup>TM</sup> memory\*,\*\*) 3.2 26666 6C CPU\*

Intel® Core<sup>TM</sup> i5-8600 3.1 2666 6C CPU

Intel® Core<sup>TM</sup> i5+8600 (Core i5 and 16GB Intel® Optane<sup>TM</sup> memory\*,\*\*) 3.1 2666 6C CPU\*

Intel® Core<sup>TM</sup> i5-8500 3.0 2666 6C CPU

Intel® Core<sup>TM</sup> i5+8500 (Core i5 and 16GB Intel® Optane<sup>TM</sup> memory\*,\*\*) 3.0 2666 6C CPU\*

#### 8th generation Intel® Core<sup>TM</sup> i3/Pentium processor family

Intel® Core<sup>TM</sup> i3-8100 3.6 2400 4C CPU Intel® Pentium® G5400 3.7 2400 2C CPU

\*Intel® Optane<sup>TM</sup> memory (cache) is sold separately. Intel® Optane<sup>TM</sup> memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 8th Gen or higher Intel® Core<sup>TM</sup> processor or Intel® Xeon® processor E-2100 product family or higher, BIOS version with Intel® Optane<sup>TM</sup> supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with M keys that meet NVMe<sup>TM</sup> Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

\*\*16GB Intel® Optane<sup>TM</sup> memory Available Fall 2018

#### **Technical Specifications - Hard Drives**

SATA Hard Drives for HP Workstations

500GB SATA 7200 rpm Capacity 6Gb/s 3.5" HDD

Capacity 500GB
Protocol SATA
Form Factor SFF (2.5")
Controller AHCI
Rated for 24/7/365 NO
operation

Physical Size (Height) 0.28 in; .7 cm
Physical Size (Width) 2.75 in; 6.99 cm
Media Diameter 2.5 in: 6.36 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Up to 600MB/s

Synchronous Transfer Rate (Maximum)

**Operating Temperature** 32° to 140° F (0° to 60° C)

1TB SATA 7200 rpm 6Gb/s Capacity
SFF HDD Protocol

Capacity1TBProtocolSATAForm FactorSFF (2.5")ControllerAHCIRated for 24/7/365NO

operation

Physical Size (Height)0.28 in; .7 cmPhysical Size (Width)2.75 in; 6.99 cmMedia Diameter2.5 in; 6.36 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

**Operating Temperature** 

32° to 140° F (0° to 60° C)

Up to 600MB/s

PCIe SSDs for HP Workstations

> HP Z Turbo Drv G2 256GB TLC PCIe SSD (Z2 MB)

Capacity 256GB Protocol PCIe

**Form Factor** M.2 in native slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 75TBW (TB Written)

**Reliability** (MTBF) 1.5M hours

Interface PCI Express 3.0 x4

Operating Temperature 32° to 158° F (0° to 70° C)

Operating Temperature 32
Performance Se

Sequential Read 2800 MB/s

Sequential Write

320 MB/s (1100 MB/s

may/Turbo

max/Turbo)

Random Read 250K IOPS Random Write 180K IOPS

## **Technical Specifications - Hard Drives**

**HP Z Turbo Drv G2 512GB** TLC PCIe SSD (Z2 MB)

Capacity 512GB PCle **Protocol** 

**Form Factor** M.2 in native slot on motherboard

Controller NVMe **NAND Type** 3D TLC

150TBW (TB Written) **Endurance** 

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

**Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance Sequential Read** 2800 MB/s

> 660 MB/s (1600 MB/s **Sequential Write**

> > max/Turbo)

**Random Read 260K IOPS 260K IOPS Random Write** 

HP Z Turbo Drv G2 1TB TLC Capacity PCIe SSD (Z2 MB)

1TB **Protocol** PCIe

**Form Factor** M.2 in native slot on motherboard

Controller NVMe **NAND Type** 3D TLC

**Endurance** 300TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4

**Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance** 

Sequential Read 3000 MB/s

> **Sequential Write** 1150 MB/s (1700 MB/s

> > max/Turbo)

**Random Read 360K IOPS Random Write 330K IOPS** 

### **Technical Specifications - Graphics**

Integrated Intel® UHD Graphics (Z2G4)

Integrated in select Intel® Xeon® E, Intel® Core<sup>TM</sup> i7, Intel® Core<sup>TM</sup> i5. and Form Factor

Intel® Core<sup>TM</sup> i3 processors.

Check specific platform specifications for selections.

**Graphics Controller** Intel® UHD Graphics

Unified Memory Architecture (UMA) frame buffer. Graphics memory is shared Memory

> with system memory. Size selectable between 32 MB to 1024 MB via BIOS setting. Default size is 128 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVMT), to provide an optimal balance between graphics and system memory use.

Check system platform specifications where Intel® HD Graphics are available. Connectors

DisplayPort<sup>TM</sup> 1.2: **Maximum Resolution** 

- up to 4096x2160 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output:

- up to 4096x2160 x 24 bpp @ 60Hz

Dual Link DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

VGA output:

- 2048 × 1536 × 32 bpp @ 85 Hz

Note: For HDMI, DVI, and VGA outputs, separate adapters required.

**Shading Architecture** Shader Model 5.0 OpenGL 4.4

**Supported Graphics APIs** 

DirectX 12

**Available Graphics Drivers** Windows 10

\*Integrated graphics will depend on processor. HD content required to view HD images

### Technical Specifications - Graphics

NVIDIA® Quadro® P1000 4GB Graphics **Maximum Resolution** DisplayPort<sup>™</sup> 1.2:

**Image Quality Features** 

- up to 4096x2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output\*:

- up to 4096x2160 x 30 bpp @ 60Hz

DLP, Interleaved, and passive stereo

**Display Output** Maximum number of displays:

- 4 direct attached monitors

Maximum number of DisplayPort<sup>TM</sup> displays possible per DisplayPort<sup>TM</sup> output (Multiple displays daisy-chained from one DisplayPort<sup>TM</sup> 1.2 port requires DisplayPort<sup>TM</sup> 1.2 MST capable displays or DisplayPort<sup>TM</sup> 1.2 MST

Stereoscopic 3D display support including NVIDIA® 3D Vision<sup>TM</sup> technology, 3E

capable hub):

- 4 1920x1200 @ 60 Hz - 2 2560x1600 @ 60 Hz - 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is

4.

Supported Graphics APIs OpenGL 4.5

DirectX 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers Microsoft Windows 10

Linux®

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

\*HDMI Flex IO Module does not support discrete graphics and will automatically switch over to Intel® UHD graphics on the Flex IO Module port when inserted into the system. Discrete graphics can be used over HDMI from one of the DP ports with an external DP-to-HDMI dongle.

### Technical Specifications - Graphics

NVIDIA® Quadro® P600 4GB Graphics **Maximum Resolution** DisplayPort<sup>TM</sup> 1.2:

- up to 4096x2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output\*:

- up to 4096x2160 x 30 bpp @ 60Hz

Image Quality Features Stereoscopic 3D display support including NVIDIA® 3D Vision<sup>TM</sup> technology, 3E

DLP, Interleaved, and passive stereo

**Display Output** Maximum number of displays:

- 4 direct attached monitors

Maximum number of DisplayPort<sup>TM</sup> displays possible per DisplayPort<sup>TM</sup> output (Multiple displays daisy-chained from one DisplayPort<sup>TM</sup> 1.2 port requires DisplayPort<sup>TM</sup> 1.2 MST capable displays or DisplayPort<sup>TM</sup> 1.2 MST

capable hub):

- 4 1920x1200 @ 60 Hz - 2 2560x1600 @ 60 Hz - 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is

4.

Supported Graphics APIs OpenGL 4.5

DirectX 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

**Available Graphics Drivers** Microsoft Windows 10

Linux®

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

\*HDMI Flex IO Module does not support discrete graphics and will automatically switch over to Intel® UHD graphics on the Flex IO Module port when inserted into the system. Discrete graphics can be used over HDMI from one of the DP ports with an external DP-to-HDMI dongle.

### Technical Specifications - Graphics

AMD Radeon<sup>TM</sup> Pro WX 4150 4GB Graphics **Maximum Resolution** DisplayPort<sup>™</sup> 1.2:

- up to 4096x2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

HDMI 2.0 output\*:

- up to 4096x2160 x 30 bpp @ 60Hz

Image Quality Features Stereoscopic 3D display support including NVIDIA® 3D Vision<sup>TM</sup> technology, 3D

DLP, Interleaved, and passive stereo

**Display Output** Maximum number of displays:

- 4 direct attached monitors

Maximum number of DisplayPort<sup>TM</sup> displays possible per DisplayPort<sup>TM</sup> output (Multiple displays daisy-chained from one DisplayPort<sup>TM</sup> 1.2 port requires DisplayPort<sup>TM</sup> 1.2 MST capable displays or DisplayPort<sup>TM</sup> 1.2 MST capable

hub):

- 4 1920x1200 @ 60 Hz - 2 2560x1600 @ 60 Hz - 1 4096x2160 @ 60 Hz

Maximum number of monitors across all available NVIDIA® Quadro® outputs is

4.

Supported Graphics APIs OpenGL 4.5

DirectX 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

**Available Graphics** 

**Drivers** 

Microsoft Windows 10

Linux®

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

\*HDMI Flex IO Module does not support discrete graphics and will automatically switch over to Intel® UHD graphics on the Flex IO Module port when inserted into the system. Discrete graphics can be used over HDMI from one of the DP ports with an external DP-to-HDMI dongle.

### Technical Specifications - Optical and Removable Storage

**HP External Ultra-Slim DVD-RW Drive** 

Description External 9.5mm high, trav-load **Mounting Orientation** Either horizontal or vertical

USB 2.0 **Interface Type** 

**Dimensions** (WxHxD) 144 x 14 x 137.5mm

**Supported Media Types** DVD-RAM

DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

**Access Times Full Stroke DVD** 160ms (typical for Random Stroke)

> **Full Stroke CD** 140ms (typical for Random Stroke)

**Maximum Data Transfer** 

Rates

**CD ROM Read** 

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

**DVD ROM Read** DVD-RAM Up to 8X

> DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

**Power** USB 2.0 DC power Source

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

5 VDC -< 800 mA typical, <1600 mA maximum **DC Current** 

**Operating Environmental Temperature** 

(all conditions noncondensing)

41° to 104° F (5° to 40° C)

**Relative Humidity** 15% to 80% 84° F (29° C)

**Maximum Wet Bulb** 

Temperature

**Operating Systems** 

**Supported** 

Windows 10 32-bit and 64-bit, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP

Professional or Windows XP Home 32\*

Linux®

No driver is required for this device. Native support is provided by the

operating system.

**Kit Contents** HP External Ultra-Slim DVD-RW Drive DVD Writer drive, USB 2.0 type A to

mini-B cable.

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The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall

Technical Specifications - Optical and Removable Storage

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### **Technical Specifications - Networking and Communications**

Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro<sup>TM</sup> with Intel® AMT 12.0) **Connector** RJ-45

Controller Intel® I219LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

**Data Rates Supported** 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u,

802.3z

**Bus Architecture** PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for host

and management traffic (Sx low power state)

**Power Requirement** Requires 3.3V (integrated regulators for core Vdc)

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI, Advanced

cable diagnostic, loopback modes,

AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

Intel® 9560 Wireless LAN (802.11ac) and Bluetooth 5 Module **Connector** M.2 (Supports 2230 form factor; E Key) Motherboard Interface

**Controller** Intel® Dual Band Wireless-AC 9560

**Compliance** Wireless LAN: IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i,

802.11h, 802.11w, CCX 4.x/CCX Lite, WMM, WPA, WPA2, APS, WPS 2.0,

**Protected Management Frames** 

Bluetooth®: Dual Mode Bluetooth® 2.1, 2.1+EDR, 3.0, 4.0, BLE, 4.2, and 5

Bus Architecture PCI Express Gen3 x1 and USB 2.0

**Power Requirement** Requires 3.3V; 1.65W TDP

Management Capabilities Wake on WLAN (in all sleep states, excluding Max Power Savings mode), WFA

Management Frame Protection (802.11w), vPro/WiAMT Not Currently Supported, F10 BIOS Menu option to disable/enable WLAN and Bluetooth® radios, supports seamless roaming between 802.11 wireless access points

**Throughput** Max PHY throughput 1.73 Gbps (802.11ac) for WLAN

### Technical Specifications – Miscellaneous Features

HP Z2 Mini G4 VESA Sleeve	Mechanical	<b>Dimensions</b> (H x W x D)	Unpackaged Packaged	70 mm x 224 mm x 223 mm (2.75 x 8.81 x 8.77 in) 305 x 102 x 289 -mm (12 x 4 x 11.38 in)
		Weight	Unpackaged	1.7 kg (3.7 lb)
			Packaged	2.27 (5.0-lb)
	Other	Option kit contents	HP Z2 Mini G4 VE warranty card.	ESA Sleeve, mounting screws, installation guide,
	Limited Warranty			ne-year limited warranty. Technical support is ay, online and support forums. Certain restrictions and

HP Elite USB-C	Mechanical	Dimensions	Unpackaged	TBD
Docking Station (TBD)		(H x W x D)	Packaged	TBD
		Weight	Unpackaged	TBD
			Packaged	TBD
	Other	Option kit contents	HP Z2 Mini G4 VES warranty card. TB	A Sleeve, mounting screws, installation guide, D
	Limited The HP Z2 Mini G4 VESA Sleeve carries a one-year limited warranty. Technic available seven days a week, 24 hours a day, online and support forums. Cel			•

### MISCELLANEOUS FEATURES

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

exclusions apply. TBD

#### Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - O Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
    - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically)
    - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy + 3 white User must enter; key sequence to proceed with recovery by policy + 3 white User must enter a key sequence to proceed with recovery by policy
    - 2 red + 4 white BIOS recovery is in progress + 4 white BIOS recovery is in progress + 4 white BIOS recovery is progress
    - 3 red + 2 white Memory could not be initialized + 2 white Memory could not be initialized + 2 white Memory could not be initialized
    - 3 red + 3 white Graphics adaptor could not be found + 3 white Graphics adaptor could not be found + 3 white Graphics adaptor could not be found
    - 3 red + 4 white Power supply failure / not connected + 4 white Power supply failure / not connected + 4 white Power supply failure / not connected
    - 3 red + 5 white Processor not installed + 5 white Processor not installed + 5 white Processor not installed

### Technical Specifications – Miscellaneous Features

- 3 red + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature
- 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceede its temperature threshold / system thermal shutdown
- 4 red + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold
- 5 red + 2 white System controller firmware is not valid
- 5 red + 3 white System controller detected BIOS is not executing
- 5 red + 4 white BIOS could not complete initialization / PCA failure
- 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

## **Summary of Changes**

Date of change:	Version History:	Description of change:
	From v1 to v2	

title

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